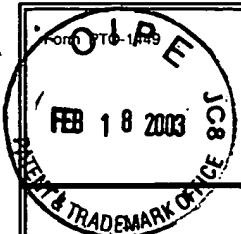


| Form PTO-1449 | | U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | | ATTY. DOCKET NO. MI22-1694 | | SERIAL NO. 09/885,393 | |
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